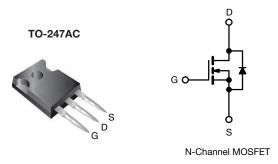
**Vishay Siliconix** 



### **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.25		
Q <sub>g</sub> max. (nC)	122			
Q <sub>gs</sub> (nC)	14			
Q <sub>gd</sub> (nC)	23			
Configuration	Single			

**FEATURES** 

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG17N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	800	V		
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	15		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		10	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	45		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy b		E <sub>AS</sub>	353	mJ		
Maximum power dissipation		P <sub>D</sub>	208	W		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C		d\//dt	70	V/ns	
Reverse diode dV/dt <sup>d</sup>		dV/dt	5.1	v/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 5.0 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

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COMPLIANT

HALOGEN

FREE

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### SiHG17N80E

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THERMAL RESISTANCE RAT									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62			°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.6							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI	
Static						•	1		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, I <sub>D</sub> = 2	250 μA	800	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1$ mA		-	1.08	-	V/°		
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V		
Gate-source leakage		$V_{GS} = \pm 20 V$			-	-	± 100	nA	
	I <sub>GSS</sub>	$V_{GS} = \pm 30 V$			-	-	± 1	μA	
Zero gate voltage drain current		$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	P		
	I <sub>DSS</sub>	_	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$			-	10	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		p = 8.5 A	-	0.25	0.29	Ω	
Forward transconductance	g <sub>fs</sub>		= 30 V, I <sub>D</sub> =		-	8.7	-	S	
Dynamic	015								
Input capacitance	C <sub>iss</sub>		<u>۷</u>		-	2408	-	1	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	81	-	pF		
Reverse transfer capacitance	C <sub>rss</sub>			-	9	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	58	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	296	-			
Total gate charge	Qg				-	61	122		
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 8.5 A, V <sub>DS</sub> = 480 V		-	14	-	nC		
Gate-drain charge	Q <sub>gd</sub>		-		-	23	-		
Turn-on delay time	t <sub>d(on)</sub>				-	22	44		
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 8.5 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$ f = 1 MHz, open drain		-	24	48	- ns		
Turn-off delay time	t <sub>d(off)</sub>			-	71	142			
Fall time	t <sub>f</sub>			-	26	52			
Gate input resistance	Rg			0.3	0.7	1.4	Ω		
Drain-Source Body Diode Characteristi									
Continuous source-drain diode current	ا <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	A		
Pulsed diode forward current	I <sub>SM</sub>			-	-	45			
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 8.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	v		
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 8.5 \text{ A},$ dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	416	832	n		
Reverse recovery charge	Q <sub>rr</sub>			-	6.4	12.8	μ		
Reverse recovery current	I <sub>RRM</sub>			-	27	-	A		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

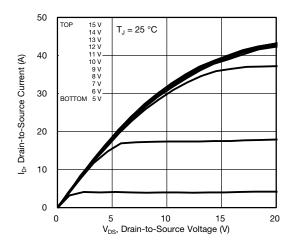
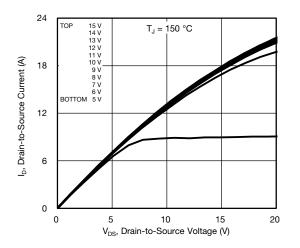


Fig. 1 - Typical Output Characteristics





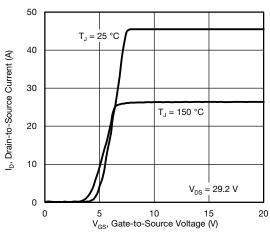


Fig. 3 - Typical Transfer Characteristics

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3.5 = 8.5 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 3.0 2.5 (Normalized) 1.5 1.0 10 V \_ 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

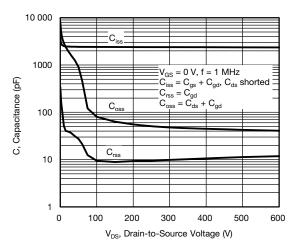


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

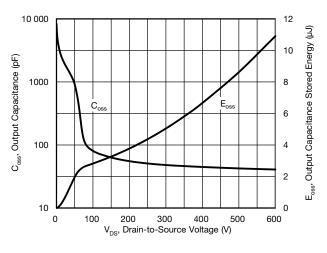


Fig. 6 - Coss and Eoss vs. VDS

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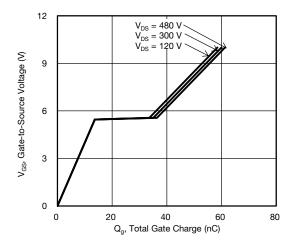


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

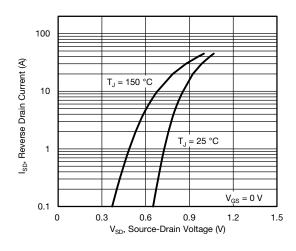


Fig. 8 - Typical Source-Drain Diode Forward Voltage

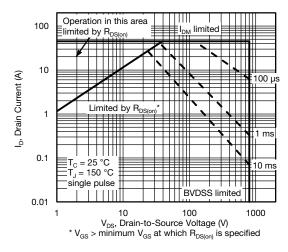


Fig. 9 - Maximum Safe Operating Area

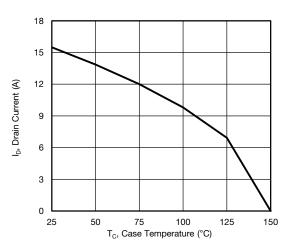


Fig. 10 - Maximum Drain Current vs. Case Temperature

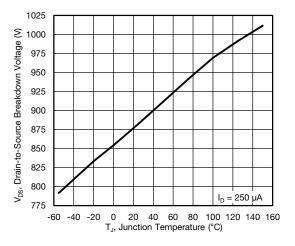


Fig. 11 - Temperature vs. Drain-to-Source Voltage

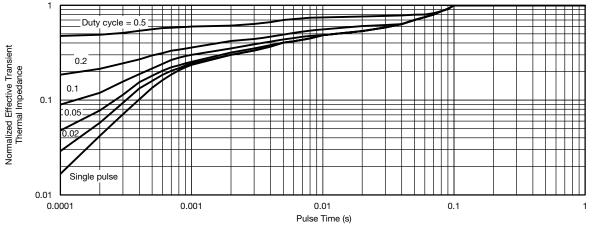
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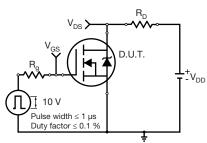


Fig. 13 - Switching Time Test Circuit

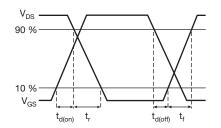


Fig. 14 - Switching Time Waveforms

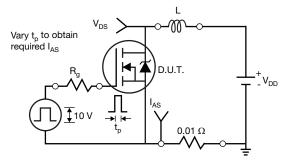


Fig. 15 - Unclamped Inductive Test Circuit

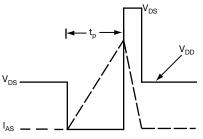


Fig. 16 - Unclamped Inductive Waveforms

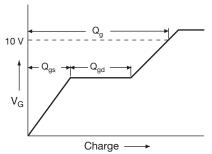


Fig. 17 - Basic Gate Charge Waveform

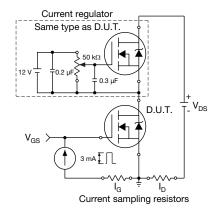


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

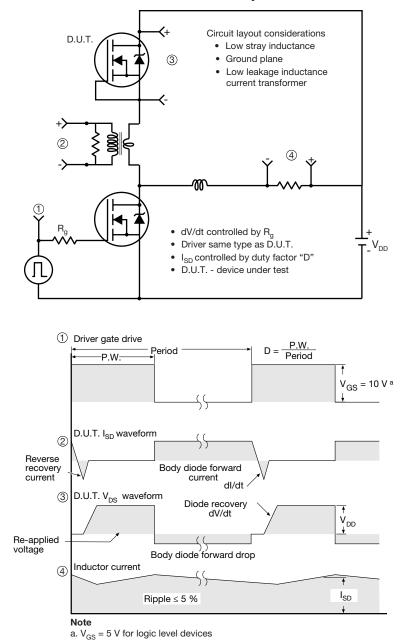


Fig. 19 - For N-Channel

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